









# **CEP6060N**

#### 60V ▲ 19mΩ ▲ 42A ▲ Si MOSFET

SILICON Si MOSFET ▲ THT type
N-channel enhancement mode
UL94V-0 rated flame retardant epoxy
TO220-3L package

Super high dense cell density for extremely low R<sub>DS(ON)</sub> **High power and current handling capability** 

## **MAXIMUM RATINGS**

| Parameter (T <sub>c</sub> = 25°C, unless otherwise noted) |                                   | Characteristics |
|---|-----------------------------------|-----------------|
| Drain-Source Voltage                                      | V <sub>DS</sub>                   | 60V             |
| Gate-Source Voltage                                       | V <sub>GS</sub>                   | ±20V            |
| Continuous Drain Current at T <sub>C</sub> = 25°C         | I <sub>D</sub>                    | 42A             |
| Pulsed Drain Current Note 1                               | I <sub>DM</sub> Note 4            | 168A            |
| Maximum Power Dissipation at T <sub>c</sub> = 25°C        | P <sub>D</sub>                    | 88W             |
| Power Dissipation Derating above 25°C                     | $\Delta P_D$                      | 0.59W/°C        |
| Operating and Storage Temperature Range                   | T <sub>J</sub> , T <sub>STG</sub> | -65°C to +175°C |

## THERMAL CHARACTERISTICS

| Parameter                               | Symbol             | Limit    |
|---|--------------------|----------|
| Thermal Resistance, Junction-to-Case    | R <sub>TH_JC</sub> | 1.7°C/W  |
| Thermal Resistance, Junction-to-Ambient | R <sub>TH_JA</sub> | 62.5°C/W |

## **APPLICATIONS**

| <b>Battery Management</b> |           | DC  | Industrial | Power    |
|---------------------------|-----------|-----|------------|----------|
| Systems                   | Converter | Fan | Control    | Switches |
| +4-                       |           |     |            |          |

#### **PIN DESCRIPTION**

| Circuit Diagram | Outline - Front View | Pin No.     | Description             |
|-----------------|----------------------|-------------|-------------------------|
| G (1) S (3)     |                      | 1<br>2<br>3 | Gate<br>Drain<br>Source |



## **ELECTRICAL CHARACTERISTICS** ▲ T<sub>C</sub> = 25°C, unless otherwise noted

| Item   | Condition  | Symbol              | Min. | Тур. | Max. | Unit |
|--|--|---------------------|------|------|------|------|
| Off Characteristics                          |  |                     |      |      |      |      |
| Drain-Source Breakdown Voltage               | $V_{GS} = 0V$ , $I_{D} = 250\mu A$   | BV <sub>DSS</sub>   | 60   |      |      | V    |
| Zero Gate Voltage Drain Current              | $V_{DS} = 60V$ , $V_{GS} = 0V$   | I <sub>DSS</sub>    |      |      | 25   | μΑ   |
| Gate Body Leakage Current, Forward           | $V_{GS} = 16V$ , $V_{DS} = 0V$   | I <sub>GSSF</sub>   |      |      | 100  | nA   |
| Gate Body Leakage Current, Reverse           | $V_{GS} = -16V, V_{DS} = 0V$   | $I_{GSSR}$          |      |      | -100 | nA   |
| On Characteristics Note 2                    |  |                     |      |      |      |      |
| Gate Threshold Voltage                       | $V_{GS} = V_{DS}$ , $I_{D} = 250 \mu A$                                    | $V_{GS(th)}$        | 2    |      | 4    | V    |
| Static Drain-Source On-Resistance            | $V_{GS}$ = 10V, $I_D$ = 24A  | R <sub>DS(ON)</sub> |      | 19   | 25   | mΩ   |
| Dynamic Characteristics Note 3               |  |                     |      |      |      |      |
| Forward Transconductance                     | $V_{DS} = 10V, I_{D} = 24A$  | <b>g</b> FS         |      | 40   |      | S    |
| Input Capacitance                            | $V_{DS} = 25V$ , $V_{GS} = 0V$ , $f = 1MHz$                                | C <sub>ISS</sub>    |      | 1320 |      | рF   |
| Output Capacitance                           | $V_{DS} = 25V$ , $V_{GS} = 0V$ , $f = 1MHz$                                | Coss                |      | 310  |      | pF   |
| Reverse Transfer Capacitance                 | $V_{DS} = 25V$ , $V_{GS} = 0V$ , $f = 1MHz$                                | C <sub>RSS</sub>    |      | 40   |      | pF   |
| Switching Characteristics Note 3             |  |                     |      |      |      |      |
| Turn-On Delay Time                           | $V_{DD}$ = 30V, $V_{GS}$ = 10V, $I_{D}$ = 19A, $R_{G(ext)}$ = 4.7 $\Omega$ | t <sub>D(ON)</sub>  |      | 16   | 32   | ns   |
| Turn-On Rise Time                            | $V_{DD}$ = 30V, $V_{GS}$ = 10V, $I_D$ = 19A, $R_{G(ext)}$ = 4.7 $\Omega$   | $t_R$               |      | 3    | 6    | ns   |
| Turn-Off Delay Time                          | $V_{DD}$ = 30V, $V_{GS}$ = 10V, $I_{D}$ = 19A, $R_{G(ext)}$ = 4.7 $\Omega$ | t <sub>D(OFF)</sub> |      | 36   | 72   | ns   |
| Turn-Off Fall Time                           | $V_{DD}$ = 30V, $V_{GS}$ = 10V, $I_D$ = 19A, $R_{G(ext)}$ = 4.7 $\Omega$   | t <sub>F</sub>      |      | 4    | 8    | ns   |
| Total Gate Charge                            | $V_{DS} = 48V$ , $V_{GS} = 10V$ , $I_D = 38A$                              | $Q_{G}$             |      | 28.7 | 38.1 | nC   |
| Gate Source Charge                           | $V_{DS} = 48V$ , $V_{GS} = 10V$ , $I_D = 38A$                              | $Q_{GS}$            |      | 6.3  |      | nC   |
| Gate Drain Charge                            | $V_{DS}$ = 48V, $V_{GS}$ = 10V, $I_{D}$ = 38A                              | $Q_{GD}$            |      | 9.7  |      | nC   |
| <b>Drain-Source Diode Characteristics a</b>  | Drain-Source Diode Characteristics and Maximum Ratings                     |                     |      |      |      |      |
| Drain-Source Diode<br>Forward Current        |  | Is                  |      |      | 42   | Α    |
| Drain-Source Diode<br>Forward Voltage Note 2 | V <sub>GS</sub> = 0V, I <sub>S</sub> = 24A                                 | $V_{SD}$            |      |      | 1.3  | V    |

#### Notes

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2: Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 3: Guaranteed by design, not subject to production testing.
- 4: Pulse width limited by safe operating area.



#### REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

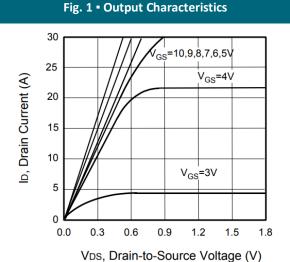


Fig. 2 • Transfer Characteristics

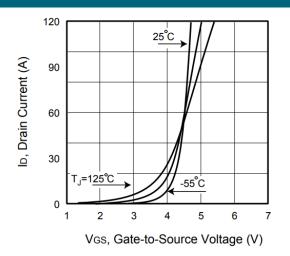


Fig. 3 • Capacitance

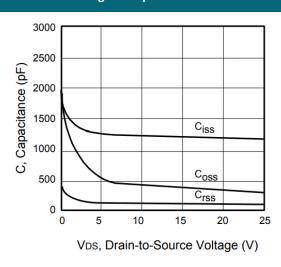


Fig. 4 • On-Resistance Variation with Temperature

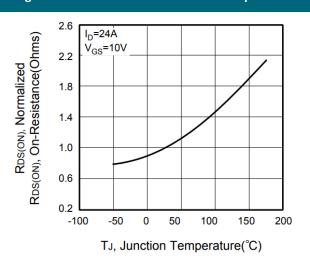


Fig. 5 • Gate Threshold Variation with Temperature

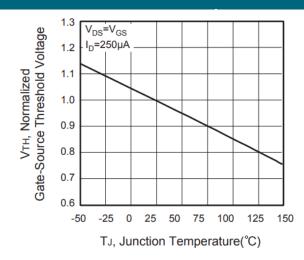
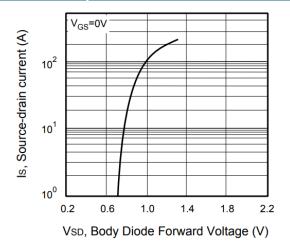


Fig. 6 • Body Diode Forward Voltage Variation with Source Current



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#### REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

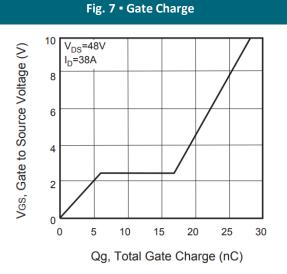


Fig. 8 • Maximum Safe Operating Area

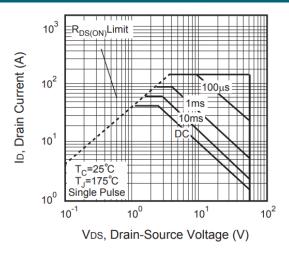
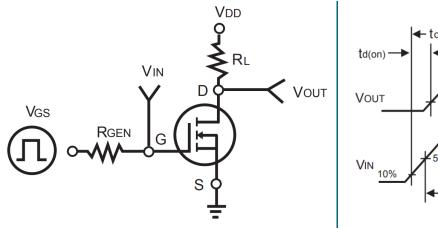


Fig. 9 • Switching Test Circuit

Fig. 10 • Switching Waveforms



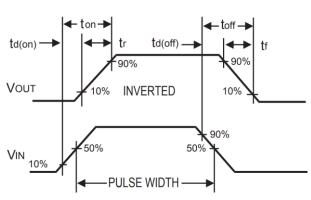
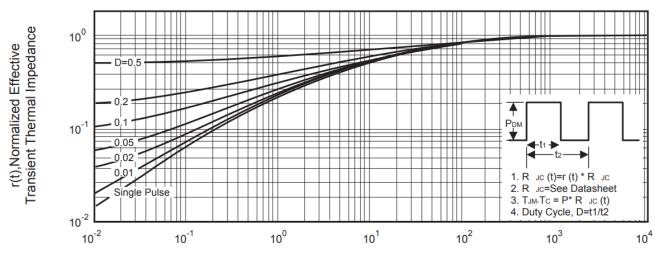


Fig. 11 - Normalized Thermal Transient Impedance Curve

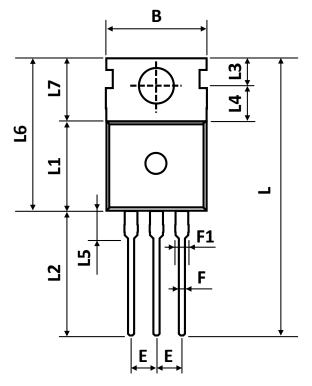


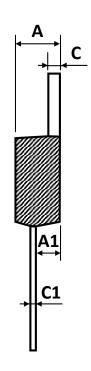
Square Wave Pulse Duration (msec)

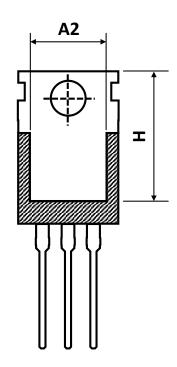
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## **PACKAGE OUTLINE**







| Sym | Millimeters (Min.) | Millimeters (Typ.) | Millimeters (Max.) |
|-----|--------------------|--------------------|--------------------|
| Α   | 4.43               | 4.53               | 4.63               |
| A1  | 2.30               | 2.40               | 2.50               |
| A2  | 7.70               | 7.90               | 8.10               |
| В   | 9.80               | 10.00              | 10.20              |
| С   | 1.25               | 1.30               | 1.40               |
| C1  | 0.45               | 0.50               | 0.60               |
| D   | 3.45               | 3.60               | 3.70               |
| E   | 2.45               | 2.54               | 2.60               |
| F   | 0.70               | 0.80               | 0.95               |
| F1  | 1.15               | 1.33               | 1.50               |
| L   | 26.80              | 28.80              | 30.80              |
| L1  | 9.20               | 9.30               | 9.40               |
| L2  | 12.80              | 13.10              | 13.40              |
| L3  | 2.70               | 2.80               | 2.90               |
| L4  | 3.50               | 3.70               | 3.80               |
| L5  | 2.60               | 2.90               | 3.20               |
| L6  | 15.40              | 15.80              | 16.20              |
| L7  | 6.20               | 6.50               | 6.80               |
| Н   | 12.95              | 13.25              | 13.55              |

## **ORDERING INFORMATION**

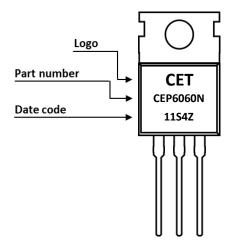
| Part Number | Package   | Packing | Tube Qty. | Inner Box Qty. | Outer Box Qty. |
|-------------|-----------|---------|-----------|----------------|----------------|
| CEP6060N    | TO-220-3L | Tube    | 50pcs     | 1,000pcs       | 4,000pcs       |

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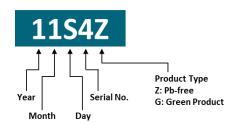


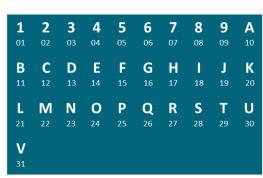
#### **PART MARKING**



#### **DATE CODE**

Example: 11S4Z



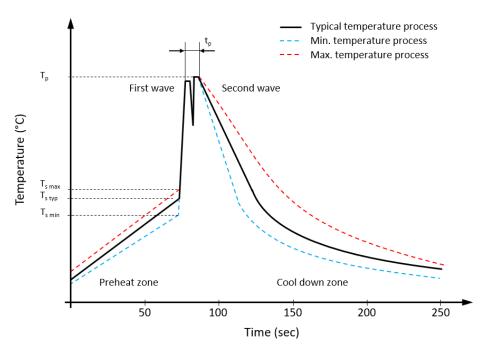


Coding list for "Day"





## RECOMMENDED WAVE SOLDERING PROFILE A THT PACKAGE



## Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

| Profile Features                                 |                    | Value ▲ Sn-Pb Assembly                     | Value ▲ Pb-free Assembly                   |
|--|--------------------|--|--|
| Preheat temperature min.                         | $T_{smin}$         | 100 °C                                     | 100 °C                                     |
| Preheat temperature typical                      | T <sub>s typ</sub> | 120 °C                                     | 120 °C                                     |
| Preheat temperature max.                         | $T_{smax}$         | 130 °C                                     | 130 °C                                     |
| Preheat time $t_s$ from $T_{smin}$ to $T_{smax}$ | $t_s$              | 70 seconds                                 | 70 seconds                                 |
| Peak temperature                                 | $T_p$              | 235 °C to 260 °C                           | 245 °C to 260 °C                           |
| Time of actual peak temperature                  | t <sub>p</sub>     | Max. 10 seconds<br>Max. 5 second each wave | Max. 10 seconds<br>Max. 5 second each wave |
| Ramp-down date min.                              |                    | ~ 2 °C/second                              | ~ 2 °C/second                              |
| Ramp-down rate typical                           |                    | ~ 3.5 °C/second                            | ~ 3.5 °C/second                            |
| Ramp-down rate max.                              |                    | ~ 5 °C/second                              | ~ 5 °C/second                              |
| Time 25°C to 25°C                                |                    | 4 minutes                                  | 4 minutes                                  |



#### **REVISION TABLE**

| Revision | Date       | Status          | Notes               |
|----------|------------|-----------------|---------------------|
| 001      | 30/09/2022 | Initial release | Initial publication |
|          |            |                 |                     |
|          |            |                 |                     |
|          |            |                 |                     |
|          |            |                 |                     |
|          |            |                 |                     |

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